

MMSZ4688

5% TOLERANCE

General Description:

Half watt, General purpose, Medium Current Surface Mount Zener in the SOD-123 package. The SOD-123 package has the same footprint as the glass mini-melf (LL-34) package & provides a convenient alternative to the Leadless package.

Features:

- Compact surface mount with same footprint as mini-melf
- 500 mW rating on FR-4 or FR-5 board.
- Class 3 ESD rating (>16 kV) per Human Body Model

Ordering:

• 7 inch reel (178 mm); 8 mm Tape; 3,000 units per reel.

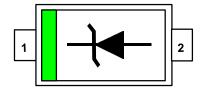
Absolute Maximum Ratings (note 1) TA = 25°C unless otherwise noted

Parameter	Value	Units					
T _{STG} - Storage Temperature	-55 to +150	οС					
T _J - Maximum Junction Temperature	-55 to +150	οС					
P _D - Total Power Dissipation at 25 ^o C	500	mW					
Derate above 25 ^o C	6.7	mW/ ^O C					
R _{ØJA} - Thermal Resistance Junction to Ambient	340	°C/W					
R _{ØJL} - Thermal Resistance Junction to Lead	150	°C/W					
	990	mV					
Lead Solder Temperature (Max 10 second duration)	260	°С					
Nominal Zener Voltage (V _Z) at 50 uA	4.7	V					
Note 1. These retires are limiting values above which the continuability of any comissed value may be imposed.							

Note 1: These ratings are limiting values above which the serviceability of any semiconductor device may be impaired

Note 2: Voltage change is equal to the difference between V_Z at 100 uA and V_Z at 10 uA.

Top Mark: **CT**1: Cathode
2: Anode

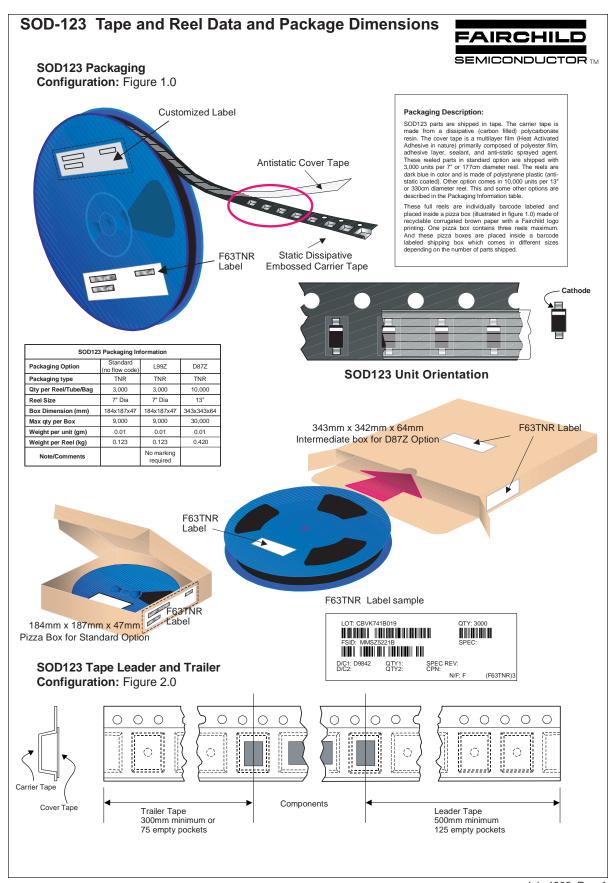


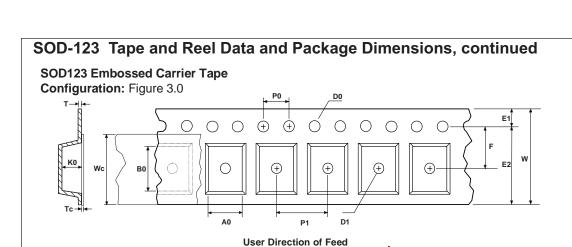
Electrical Characteristics

TA = 25°C unless otherwise noted

SYM	CHARACTERISTICS	MIN	MAX	UNITS	TEST CONDITIONS
V _z	Zener Voltage	4.47	4.94	V	$I_{ZT} = 50.0 \text{ uA D.C}$
I _R	Reverse Leakage		10	uA	$V_R = 3.0 V$
V_{F}	Forward Voltage		900	mV	I _F = 10 mA
ΔV_{Z}	Delta Zener Voltage		990	mV	$I_F = 100 \text{ uA to } 10 \text{ uA}$

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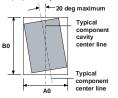


Dimensions are in millimeter														
Pkg type	A0	В0	w	D0	D1	E1	E2	F	P1	P0	КО	т	Wc	Тс
SOD123 (8mm)	1.85 +/-0.10	3.94 +/-0.10	8.0 +/-0.3	1.50 +/-0.10	1.125 +/-0.125	1.75 +/-0.10	6.25 min	3.50 +/-0.05	4.0 +/-0.1	4.0 +/-0.1	1.50 +/-0.10	0.200 +/-0.020	5.2 +/-0.2	0.06 +/-0.02

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



Sketch A (Side or Front Sectional View)
Component Rotation

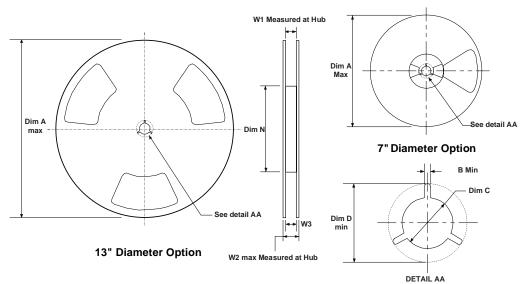


Sketch B (Top View)
Component Rotation



Sketch C (Top View)
Component lateral movement

SOD123 Reel Configuration: Figure 4.0



Dimensions are in inches and millimeters									
Tape Size	Reel Option	Dim A	Dim B	Dim C	Dim D	Dim N	Dim W1	Dim W2	Dim W3 (LSL-USL)
8mm	7" Dia	7.00 177.8	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	2.165 55	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9
8mm	13" Dia	13.00 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	4.00 100	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9

SOD-123 Tape and Reel Data and Package Dimensions, continued SOD-123 (FS PKG Code D6) Scale 1:1 on letter size paper Dimensions shown below are in: inches [millimeters] Part Weight per unit (gram): 0.01 1.2 2 mm 48 mils <u>0.071 (1.800)</u> 0.055 (1.400) 2 0.91 mm 0.91 mm 2.36 mm 36 mils 93 mils 36 mils 4.19 mm 165 mils SOD-123 LAND PADS <u>0.112 (2.850)</u> <u>0.100 (2.550)</u> <u>0.154 (3.900)</u> 0.142 (3.600) 0.071 (1.800) 0.055 (1.400) 0.046 (3.900) 0.035 (3.600) 0.028 (0.700) 0.021 (0.546) 0.013 (0.322) 0.008 (0.195) 0.004 (0.095) 0.0040 (0.1015) Min imu m 0.0005 (0.0135)

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Rev. B